ATTY DKT. NO.: U.S. SERIAL NO.: FILED:

CONF. NO.: UNKNOWN

APPLICANT: TITLE:

AMAT/7164.C1/CMP/ECP/RKK
UNKNOWN CONF. NO.: UNKNOWN
HEREWITH
APPLIED MATERIALS, INC.
MODULAR ELECTROCHEMICAL PROCESSING SYSTEM

INVENTOR: CHEN, ET AL.
EXPRESS MAIL NO.: EV351031985US

PAGE 1 of 4

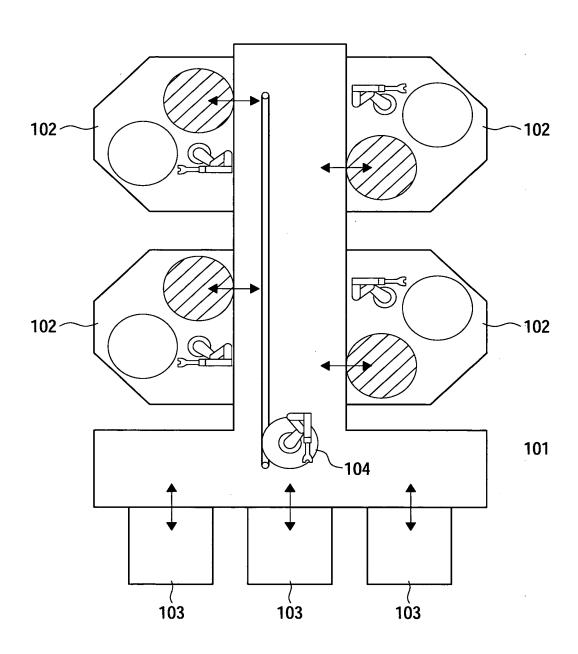


FIG. 1

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ATTY DKT. NO.:

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APPLICANT:
TITLE:
MODULAR ELECTROCHEMICAL PROCESSING SYSTEM
EXPRESS MAIL NO.:
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AMAT/7164.C1/CMP/ECP/RKK
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CHEN, ET AL.
EXPRESS MAIL NO.:

EV351031985US

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CONF. No.: UNKNOWN

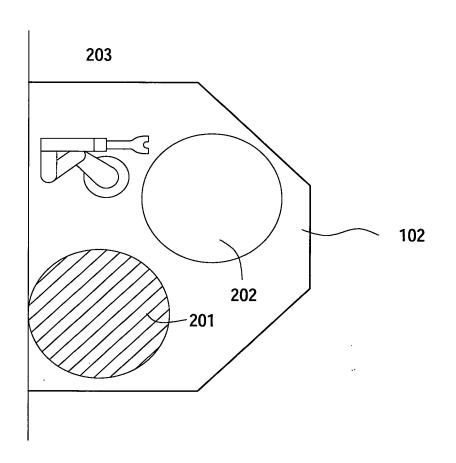


FIG. 2

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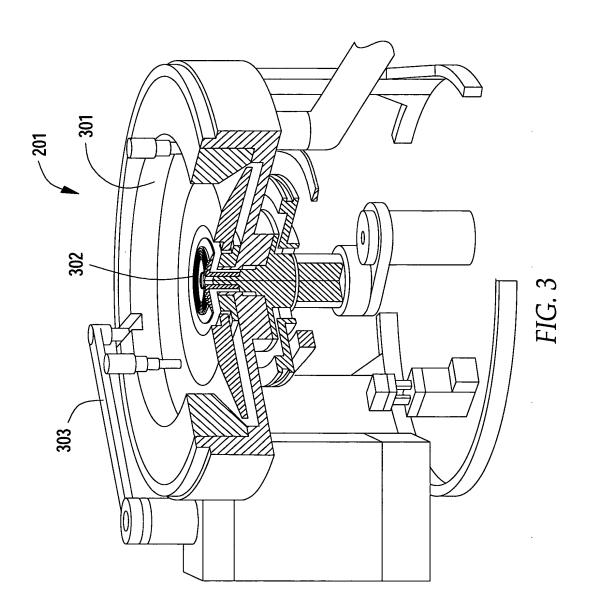
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HEREWITH
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MODULAR ELECTROCHEMICAL PROCESSING SYSTEM INVENTOR:

INVENTOR: CHEN, ET AL. EXPRESS MAIL NO.: EV351031985US

PAGE 3 of 4

CONF. No.: UNKNOWN



ATTY DKT. No.: U.S. SERIAL No.:

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AMAT/7164.C1/CMP/ECP/RKK UNKNOWN HEREWITH

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APPLICANT: TITLE: INVENTOR: CHEN, ET AL.
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